# 10502

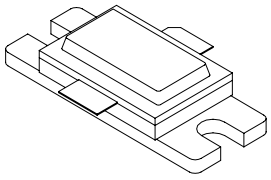
## 500 Watts, 50 Volts, Pulsed Avionics 1030 / 1090 MHz

## GENERAL DESCRIPTION

The 10502 is a high power COMMON BASE bipolar transistor. It is designed for pulsed systems in the frequency band 1030/1090 MHz, with the pulse width and duty required for MODE-S &TCAS applications. The device has gold thin-film metallization and diffused ballasting for proven highest MTTF. The transistor includes input and output prematch for broadband capability. Low thermal resistance package reduces junction temperature, extends life.

## CASE OUTLINE

**55SM**
**Common Base**



## ABSOLUTE MAXIMUM RATINGS

**Maximum Power Dissipation**

| | |
|---|---|
| Device Dissipation @ 25°C[1] | 1458 Watts |

**Maximum Voltage and Current**

| | | |
|---|---|---|
| BVces | Collector to Emitter Voltage | 65 Volts |
| BVebo | Emitter to Base Voltage | 3.5 Volts |
| Ic | Collector Current | 40 Amps |

**Maximum Temperatures**

| | |
|---|---|
| Storage Temperature | - 65 to + 200°C |
| Operating Junction Temperature | + 230°C |

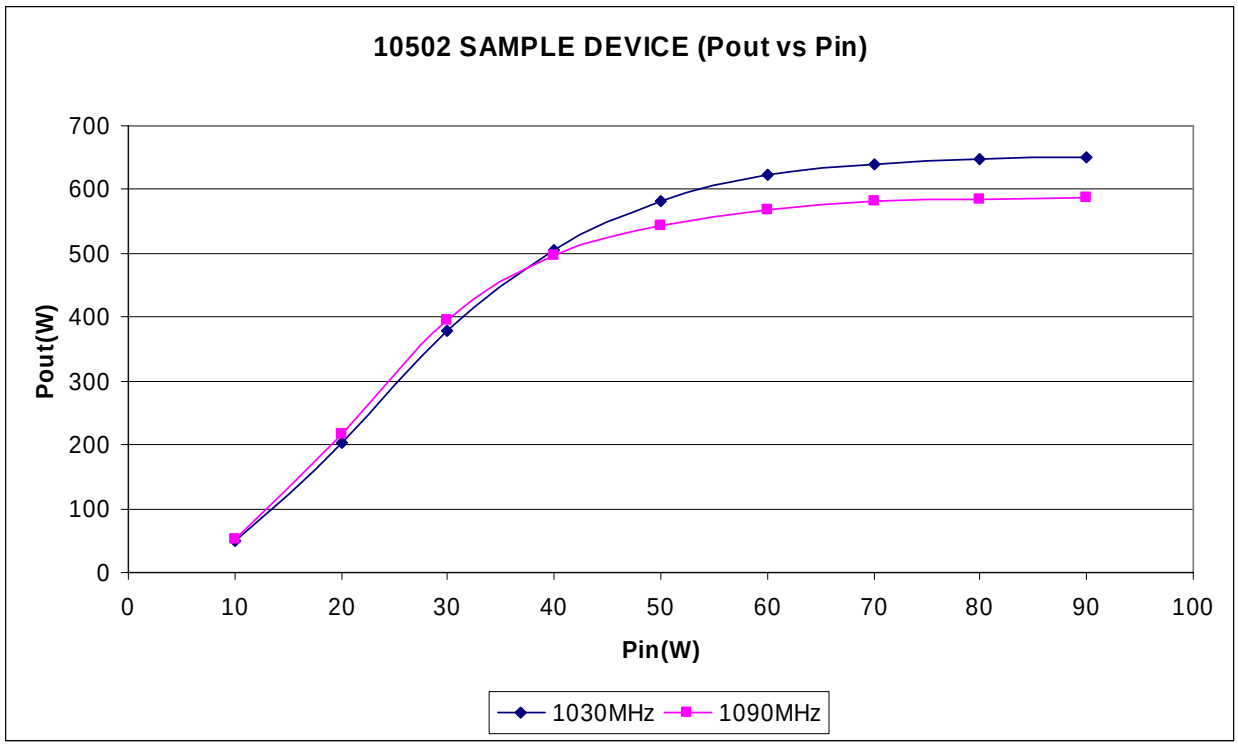
**ELECTRICAL CHARACTERISTICS @ 25 °C**

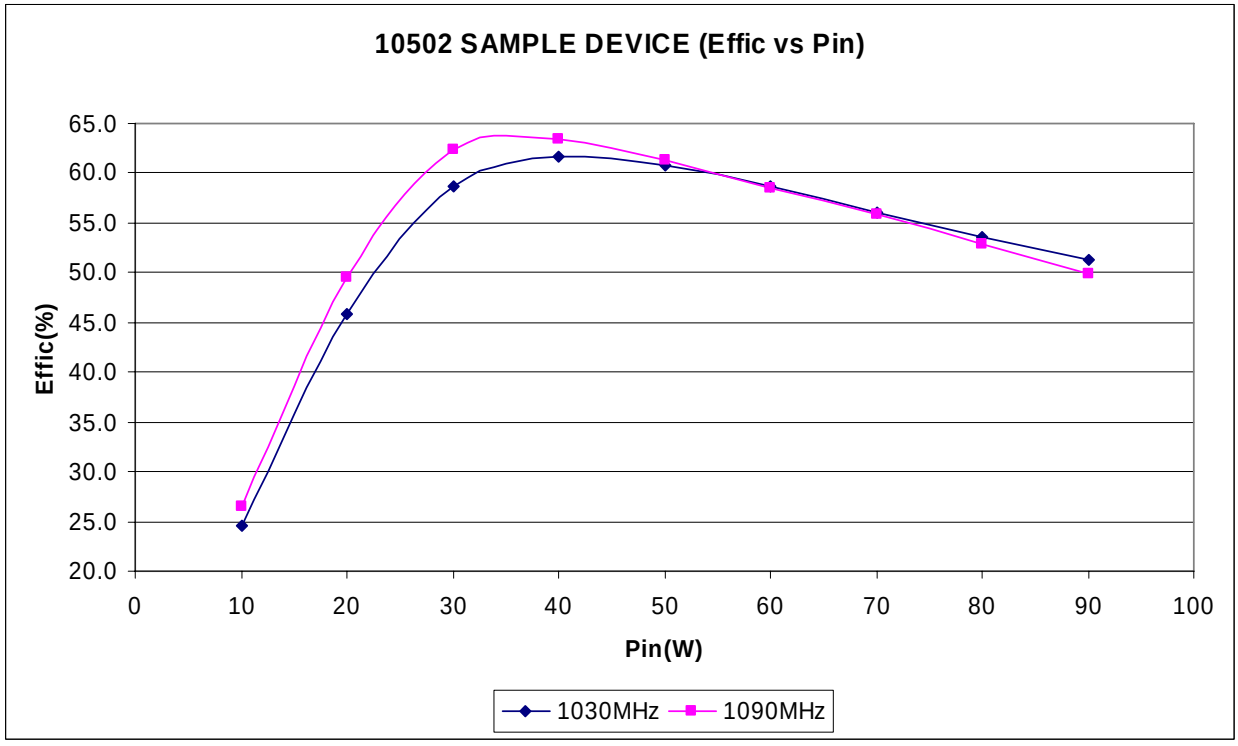
| SYMBOL | CHARACTERISTICS | TEST CONDITIONS | MIN | TYP | MAX | UNITS |
|---|---|---|---|---|---|---|
| $P_{OUT}$ | Output Power | F = 1030/1090 MHz | 500 | | | W |
| $P_{IN}$ | Input Power | $V_{CC}$ = 50 Volts | | | 70 | W |
| $P_G$ | Power Gain | PW = 32 μsec, DF = 2% | 8.5 | | | dB |
| $\eta_c$ | Collector Efficiency | | 40 | | | % |
| RL | Return Loss | | 10 | | | dB |
| VSWR | Load Mismatch Tolerance[1] | F = 1090 MHz | 10:1 | | | |

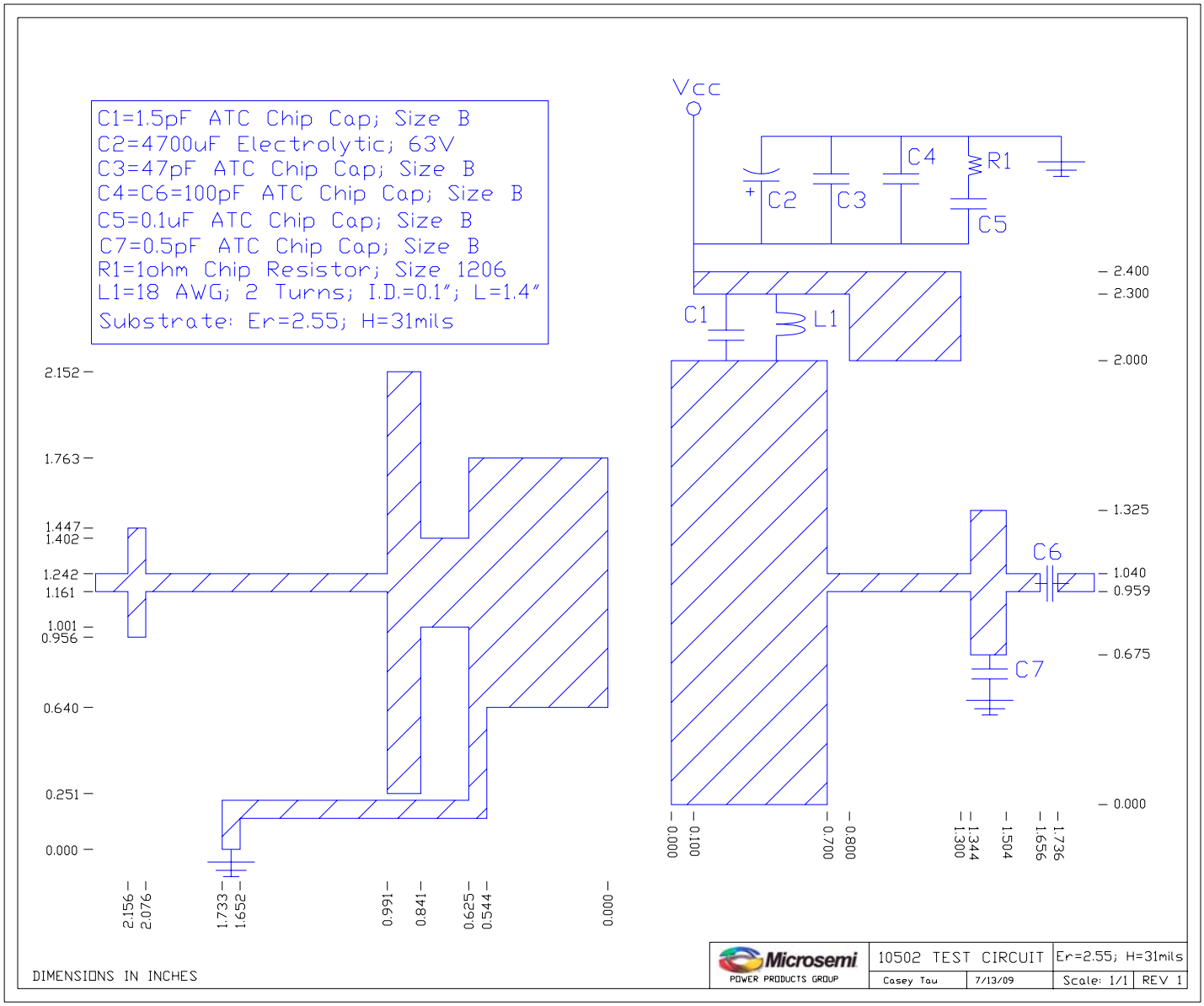
| | | | | | | |
|---|---|---|---|---|---|---|
| $BV_{EBO}$ | Emitter to Base Breakdown | Ie = 15 mA | 3.5 | | | Volts |
| $BV_{CES}$ | Collector to Emitter Breakdown | Ic = 60 mA | 65 | | | Volts |
| $I_{CBO}$ | Collector to Base Leakage | $V_{CB}$ = 36V | | | 25 | mA |
| $h_{FE}$ | DC - Current Gain | Ic = 5 A, Vce = 5 V | 20 | | | |
| θjc[1] | Thermal Resistance | | | | 0.12 | °C/W |

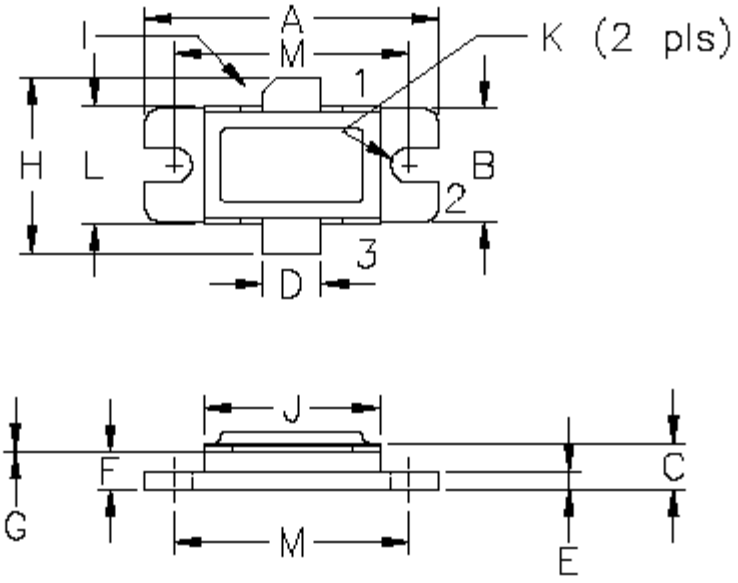
Note 1: At rated output power and pulse conditions

Rev. C: August 2010



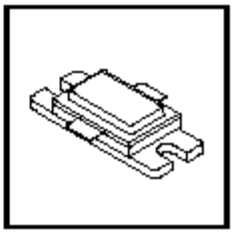





| DIM | MILLIMETER | TOL | INCHES | TOL |
|---|---|---|---|---|
| A | 25.40 | .25 | 1.000 | .010 |
| B | 9.78 | .25 | .385 | .010 |
| C | 4.87 | .19 | .192 | .007 |
| D | 5.08 | .13 | .200 | .005 |
| E | 1.53 | .13 | .060 | .005 |
| F | 3.18 | .13 | .125 | .005 |
| G | 0.08 | +.∞/−.∞ | .003 | +.002/ −.000 |
| H | 19.05 | 0.51 | .750 | .020 |
| I | 45° | 5° | 45° | 5° |
| J | 15.24 | .25 | .600 | .010 |
| K | 3.05 DIA | .13 | .120 DIA | .005 |
| L | 10.15 | .13 | .400 | .005 |
| M | 20.32 | .25 | .800 | .010 |

**STYLE 1:**
**PIN 1 = COLLECTOR**
**2 = BASE**
**3 = EMITTER**

**STYLE 2:**
**PIN 1 = COLLECTOR**
**2 = EMITTER**
**3 = BASE**



Microsemi

DWG NO.

**55SM**